

MOSFET

Small-Signal Transistor

Features

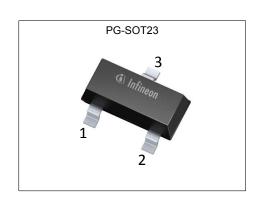
- N-channel
- Enhancement mode
- Logic level
- dv/dt rated
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

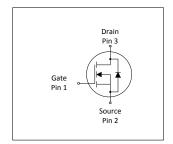
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	60	V
R _{DS(on),max} , V _{GS} =10 V	5	Ω
R _{DS(on),max} , V _{GS} =4.5 V	7.5	Ω
I _D	0.2	A
ESD Sensitivity, JESD22-A114 (HBM)	Class 0 (<250V)	











Type / Ordering Code	Package	Marking	Related Links
SN7002I	PG-SOT23	sNI	-

Small-Signal Transistor SN70021



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Parameter	Cymahal	Values			11	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I _D	-	-	0.20 0.16	А	V _{GS} =10 V, T _A =25 °C V _{GS} =4.5 V, T _A =70 °C
Pulsed drain current	I _{D,pulse}	-	-	0.8	Α	T _A =25 °C
Reverse diode dv/dt	dv/dt	-	-	6	kV/µs	I_{D} =0.2 A, V_{DS} =48 V, d <i>i</i> /d <i>t</i> =200 A/µs, $T_{j,max}$ =150 °C
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	0.36	W	T _A =25 °C, R _{thJA} =350 °C/W
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	-

Thermal characteristics 2

Thermal characteristics Table 3

Dovometer	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - ambient, minimum footprint	R _{thJA}	-	-	350	K/W	-

3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Oh a l		Values			Nata / Tank Oam little
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =250 μA
Gate threshold voltage	V _{GS(th)}	0.8	1.4	1.8	V	$V_{DS}=V_{GS}$, $I_{D}=26 \mu A$
Zero gate voltage drain current	I _{DSS}	-	-	0.1 5	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	-	10	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.3 3.5	5 7.5	Ω	V _{GS} =10 V, I _D =0.5 A V _{GS} =4.5 V, I _D =0.17 A
Transconductance	g fs	0.09	0.17	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =0.16 A

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 Table 5
 Dynamic characteristics

Parameter	Cumbal	Values			11	Note / Total Constitution
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	32	-	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	6.6	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	2.6	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	2.4	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =0.5 A, $R_{\rm G,ext}$ =6 Ω
Rise time	t _r	-	3.2	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =0.5 A, $R_{\rm G,ext}$ =6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	5.3	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =0.5 A, $R_{\rm G,ext}$ =6 Ω
Fall time	t _f	-	3.6	-	ns	$V_{\rm DD} = 30 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 0.5 \text{ A}, \ R_{\rm G,ext} = 6 \ \Omega$

 Table 6
 Gate charge characteristics

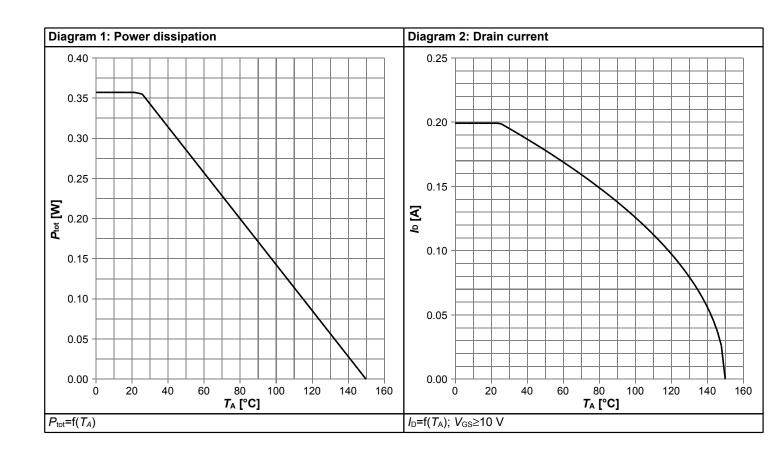
Parameter	Cumbal	Values			11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	0.14	-	nC	V_{DD} =30 V, I_{D} =0.5 A, V_{GS} =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	0.29	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =0.5 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total	Q g	-	0.9	-	nC	V_{DD} =30 V, I_{D} =0.5 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =0.5 A, $V_{\rm GS}$ =0 to 10 V

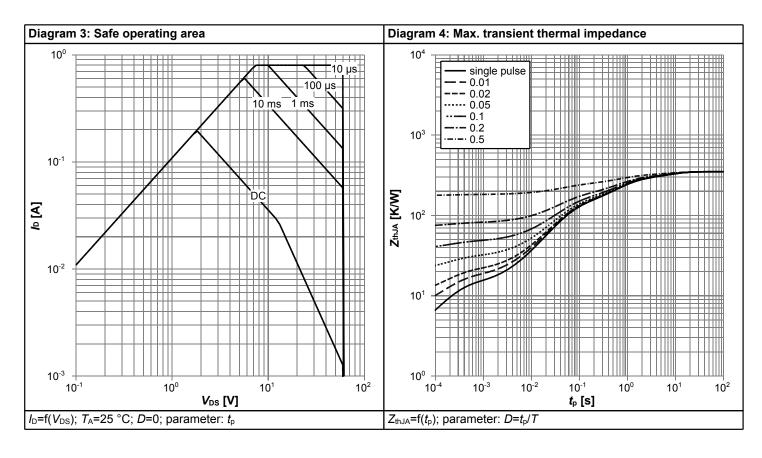
Table 7 Reverse diode

Parameter	Cumbal		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I _S	-	-	0.2	Α	<i>T</i> _A =25 °C
Diode pulse current	I _{S,pulse}	-	-	0.8	Α	<i>T</i> _A =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.2	V	V _{GS} =0 V, I _F =0.2 A, T _j =25 °C
Reverse recovery time	t _{rr}	-	14.2	21.3	ns	V _R =30 V, I _F =0.2 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge	Qrr	-	5.9	8.8	nC	V _R =30 V, I _F =0.2 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

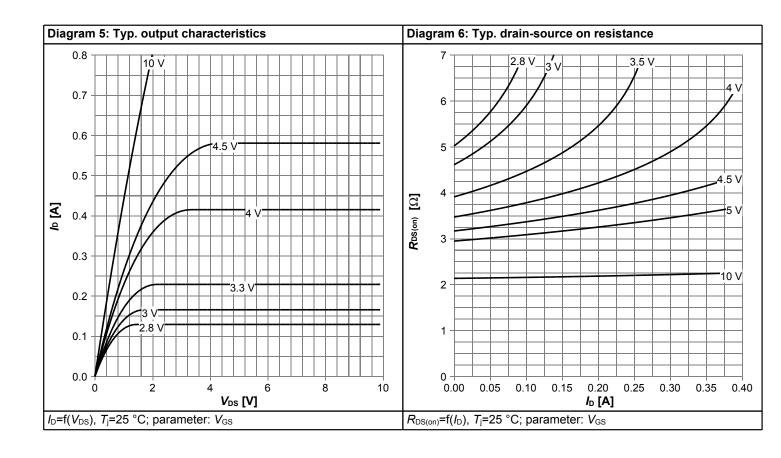


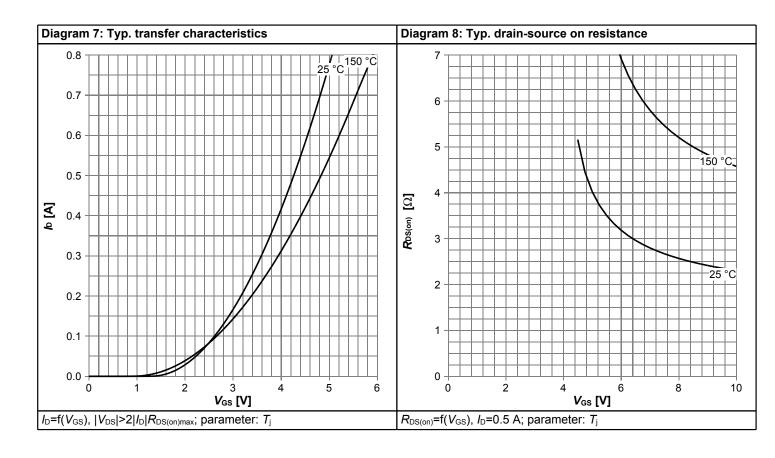
4 Electrical characteristics diagrams



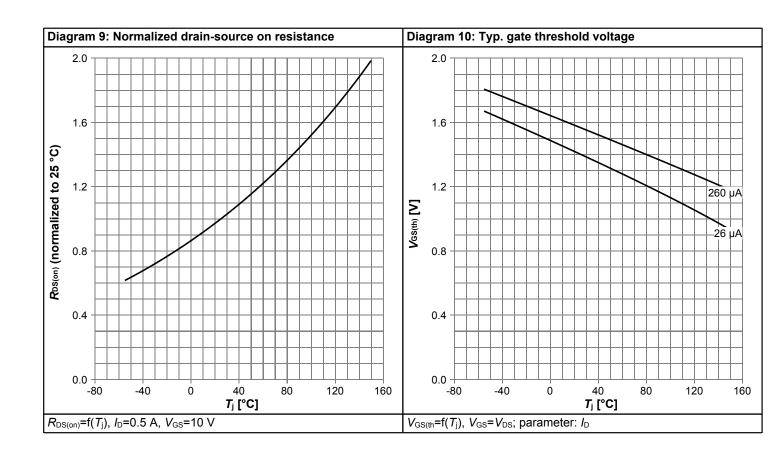


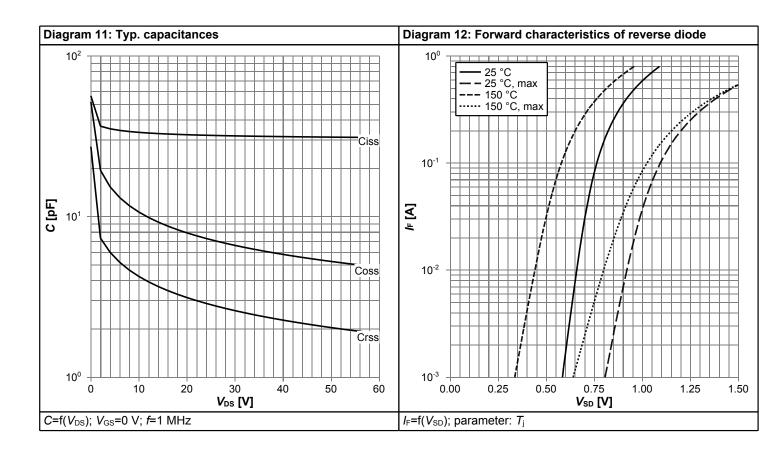




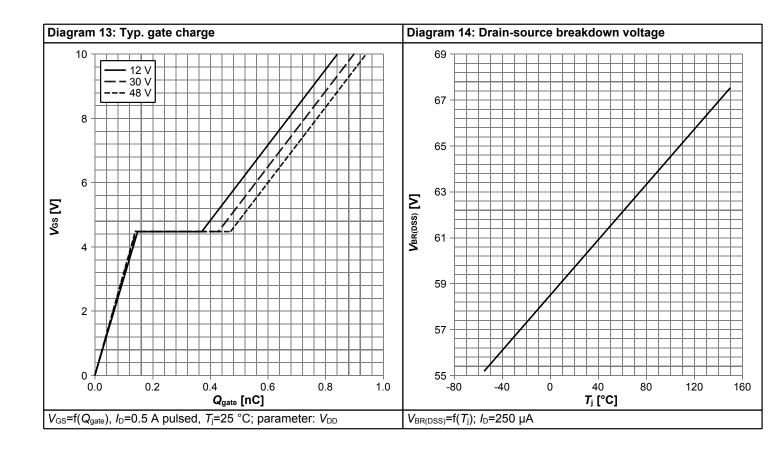


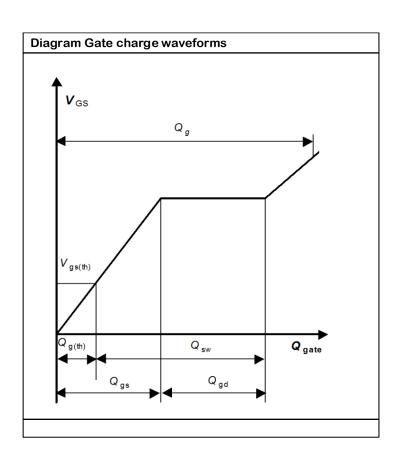






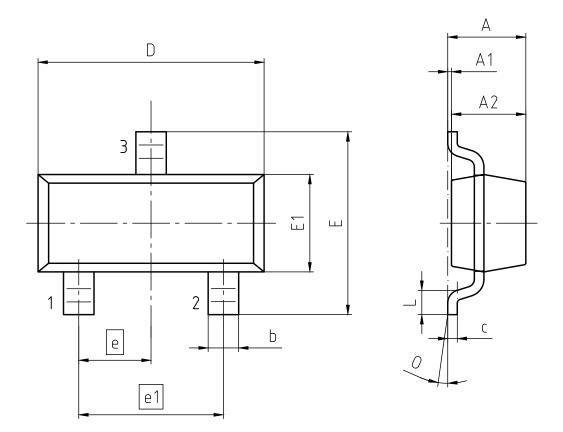








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-SOT	PG-SOT23-3-U01				
REVISION: 01	DATE: (09.12.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
Α	0.89	1.12				
A1	0.01	0.10				
A2	0.88	1.02				
b	0.30	0.50				
С	0.08	0.20				
D	2.80	3.04				
E	2.10	2.64				
E1	1.20	1.40				
е	0.9	0.95				
e1	1.90					
L	0.15 0.60					
0	0°	8°				

Figure 1 Outline PG-SOT23, dimensions in mm

Small-Signal Transistor SN70021



Revision History

SN7002I

Revision: 2023-02-07, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2021-01-26	Release of final version				
2.1	2021-03-16	Update technology naming				
2.2	2023-02-07	Update Coss and Crss				

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